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JAN 13 2006 Docket No. 60173 (71987)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: C. Huang

U.S. SERIAL NO: 10/696,198

EXAMINER: H. Trinh

FILED: October 28, 2003

GROUP: 2814

FOR: MULTI-CHIP PACKAGE DEVICE WITH HEAT SINK AND
FABRICATION METHOD THEREOFCERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being transmitted by facsimile to the U.S. Patent & Trademark Office by facsimile number 571-273-8300 on January 13, 2006.

By: 

Steven M. Jensen

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir/Madam:

AMENDMENT

Applicants are in receipt of the Office Action dated October 13, 2005 of the above-referenced application. Please amend the application as follows:

Amendments to the specification begin on page 2 of this paper.

Amendments to the claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks begin on page 5 of this paper.